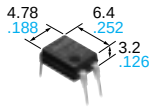
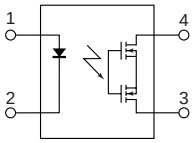
cUL pending VDE pending

GU (General Use) Type 1-Channel (Form A) High Capacity 4-Pin Type

PhotoMOS RELAYS



mm inch



FEATURES

1. Greatly increased load current.

2. Reinforced insulation 5,000 V type.

3. Greatly improved specs allow you to use this in place of mercury and mechanical relays.

4. Compact 4-pin DIP size.

TYPICAL APPLICATIONS

• Security market
(use in I/O for alarm and security devices, etc.)
• Measuring instrument market

TYPES

Type	I/O isolation voltage	Output rating*		Part No.				Packing quantity	
				Through hole terminal	Surface-mount terminal				
		Load voltage	Load current	Tube packing style		Tape and reel packing style		Tube	Tape and reel
						Picked from the 1/2-pin side	Picked from the 3/4-pin side		
AC/DC type	Reinforced 5,000 V	60 V	1.1 A	AQY212GH	AQY212GHA	AQY212GHAX	AQY212GHAZ	1 tube contains 100 pcs. 1 batch contains 1,000 pcs.	1,000 pcs.

*Indicate the peak AC and DC values.
Note: For space reasons, the initial letters of the product number “AQY”, the SMD terminal shape indicator “A” and the package type indicator "X" and "Z" are omitted from the seal.

RATING

1. Absolute maximum ratings (Ambient temperature: 25°C 77°F)

Item		Symbol	AQY212GH	Remarks
Input	LED forward current	I_F	50 mA	
	LED reverse voltage	V_R	5 V	
	Peak forward current	I_{FP}	1 A	f = 100 Hz, Duty factor = 0.1%
	Power dissipation	P_{in}	75 mW	
Output	Load voltage (peak AC)	V_L	60 V	
	Continuous load current (peak AC)	I_L	1.1 A	
	Peak load current	I_{peak}	3.0 A	100ms (1 shot), V_L = DC
	Power dissipation	P_{out}	500 mW	
Total power dissipation		P_T	550 mW	
I/O isolation voltage		V_{iso}	5,000 V AC	
Temperature limits	Operating	T_{opr}	–40°C to +85°C –40°F to +185°F	Non-condensing at low temperatures
	Storage	T_{stg}	–40°C to +100°C –40°F to +212°F	

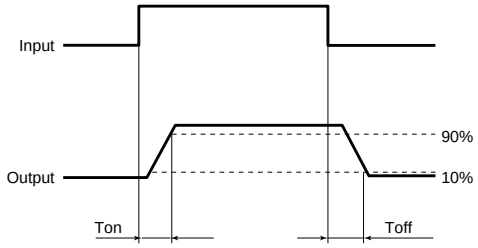
2. Electrical characteristics (Ambient temperature: 25°C 77°F)

Item			Symbol	AQY212GH	Condition
Input	LED operate current	Typical	I_{Fon}	1.1 mA	I_L = 100mA
		Maximum		3 mA	
	LED turn off current	Minimum	I_{Foff}	0.3 mA	I_L = 100mA
		Typical		1.0 mA	
	LED dropout voltage	Typical	V_F	1.14 V (1.32 V at IF = 50 mA)	I_F = 5 mA
		Maximum		1.5 V	
Output	On resistance	Typical	R_{on}	0.34 Ω	I_F = 5 mA I_L = Max. Within 1 s on time
		Maximum		0.7 Ω	
	Off state leakage current	Maximum	I_{Leak}	1 μA	I_F = 0 V_L = Max.
Transfer characteristics	Turn on time*	Typical	T_{on}	1.3 ms	I_F = 5 mA I_L = 100 mA V_L = 10 V
		Maximum		5.0 ms	
	Turn off time*	Typical	T_{off}	0.1 ms	I_F = 5 mA I_L = 100 mA V_L = 10 V
		Maximum		0.5 ms	
	I/O capacitance	Typical	C_{iso}	0.8 pF	f = 1 MHz V_B = 0
		Maximum		1.5 pF	
	Initial I/O isolation resistance	Minimum	R_{iso}	1,000 MΩ	500 V DC

Note: Recommendable LED forward current I_F = 5 to 10 mA.

For type of connection, see Page 4.

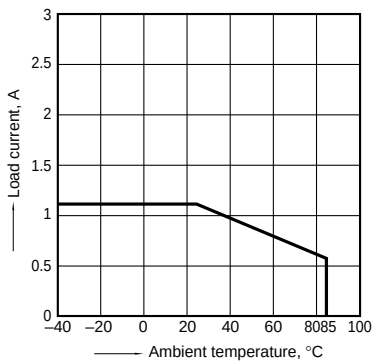
*Turn on/Turn off time



REFERENCE DATA

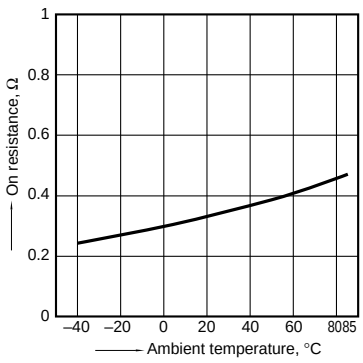
1. Load current vs. ambient temperature characteristics

Allowable ambient temperature: –40°C to +85°C
–40°F to +185°F



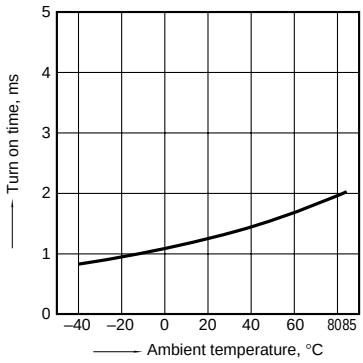
2. On resistance vs. ambient temperature characteristics

Measured portion: between terminals 3 and 4;
LED current: 5 mA; Load voltage: Max. (DC)
Continuous load current: Max.(DC)



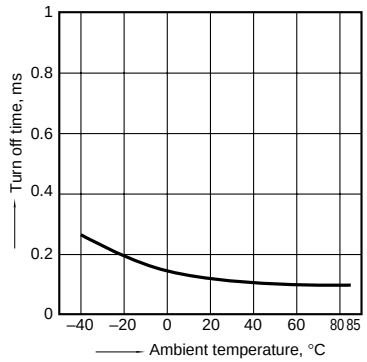
3. Turn on time vs. ambient temperature characteristics

LED current: 5 mA; Load voltage: 10 V (DC);
Continuous load current: 100 mA (DC)



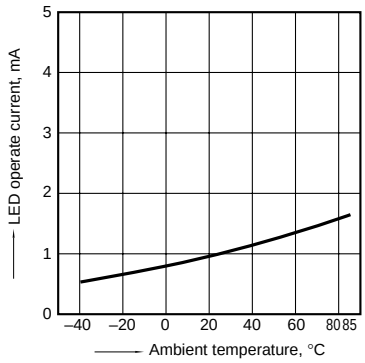
4. Turn off time vs. ambient temperature characteristics

LED current: 5 mA; Load voltage: 10 V (DC);
Continuous load current: 100 mA (DC)



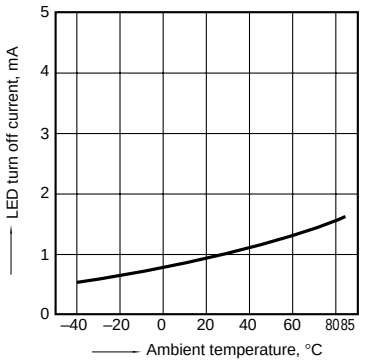
5. LED operate current vs. ambient temperature characteristics

Load voltage: 10 V (DC);
Continuous load current: 100mA (DC)



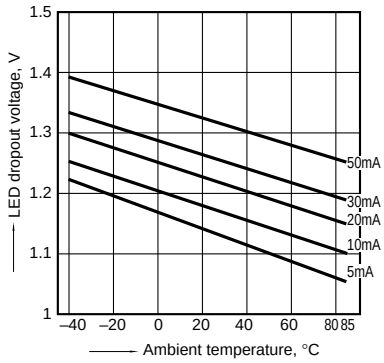
6. LED turn off current vs. ambient temperature characteristics

Load voltage: 10 V (DC);
Continuous load current: 100mA (DC)



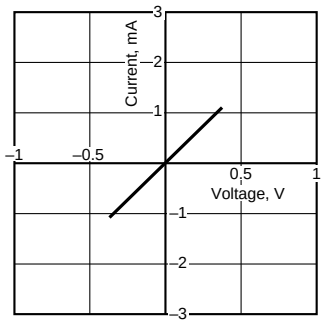
7. LED dropout voltage vs. ambient temperature characteristics

LED current: 5 to 50 mA



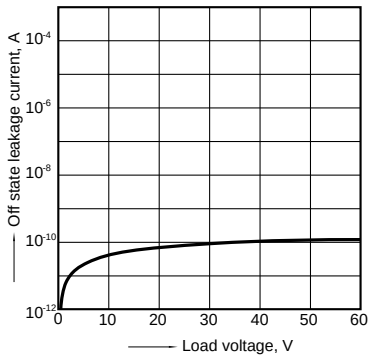
8. Voltage vs. current characteristics of output at MOS portion

Measured portion: between terminals 3 and 4;
Ambient temperature: 25°C 77°F



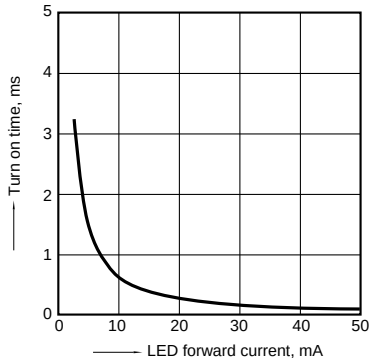
9. Off state leakage current

Measured portion: between terminals 3 and 4;
Ambient temperature: 25°C 77°F



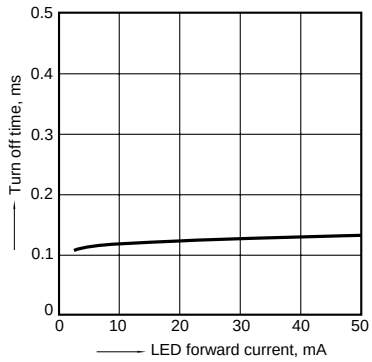
10. LED forward current vs. turn on time characteristics

Measured portion: between terminals 3 and 4;
Load voltage: 10 V (DC);
Continuous load current: 100 mA (DC);
Ambient temperature: 25°C 77°F



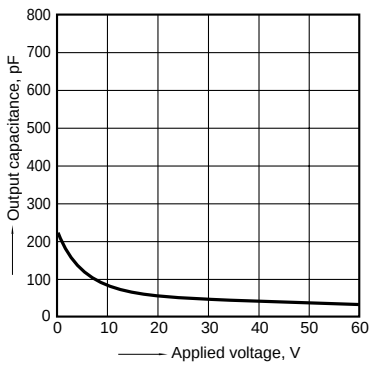
11. LED forward current vs. turn off time characteristics

Measured portion: between terminals 3 and 4;
Load voltage: 10 V (DC);
Continuous load current: 100 mA (DC);
Ambient temperature: 25°C 77°F



12. Applied voltage vs. output capacitance characteristics

Measured portion: between terminals 3 and 4;
Frequency: 1 MHz;
Ambient temperature: 25°C 77°F

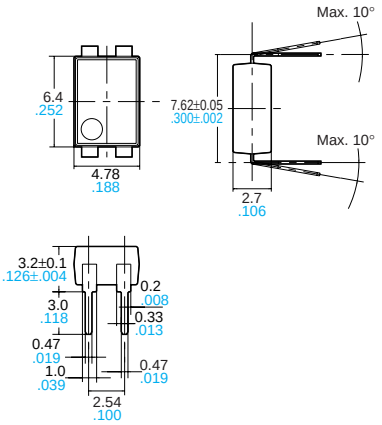


DIMENSIONS

mm inch

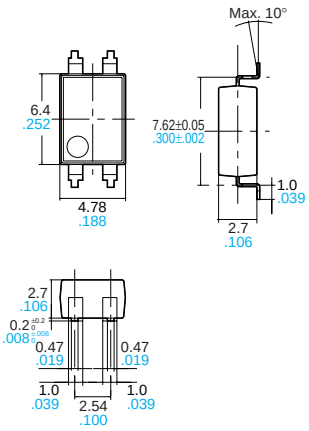


Through hole terminal type



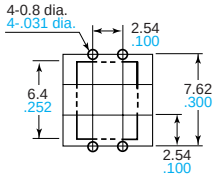
Terminal thickness = 0.2 .008
General tolerance: ±0.1 ±.004

Surface mount terminal type



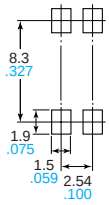
Terminal thickness = 0.2 .008
General tolerance: ±0.1 ±.004

PC board pattern (BOTTOM VIEW)



Tolerance: ±0.1 ±.004

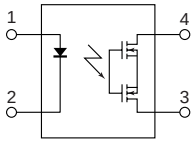
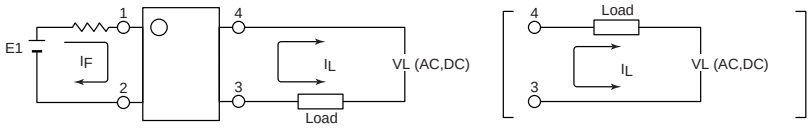
Mounting pad (TOP VIEW)



Tolerance: ±0.1 ±.004

SCHEMATIC AND WIRING DIAGRAMS

Notes: E_1: Power source at input side; I_F: LED forward current; V_L: Load voltage; I_L: Load current;

Schematic	Output configuration	Load	Connection	Wiring diagram
	1a	AC/DC	—	

Cautions for Use

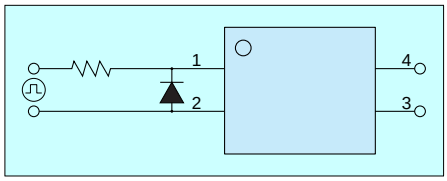
SAFETY WARNINGS

• Do not use the product under conditions that exceed the range of its specifications. It may cause overheating, smoke, or fire.
• Do not touch the recharging unit while the power is on. There is a danger of electrical shock. Be sure to turn off the power when performing mounting, maintenance, or repair operations on the relay (including connecting parts such as the terminal board and socket).
• Check the connection diagrams in the catalog and be sure to connect the terminals correctly. Erroneous connections could lead to unexpected operating errors, overheating, or fire.

NOTES

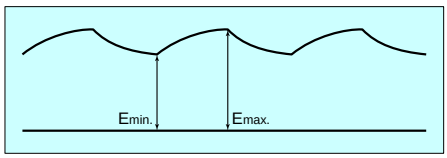
1. Short across terminals
Do not short circuit between terminals when relay is energized. There is possibility of breaking the internal IC.

2. Surge voltages at the input
If reverse surge voltages are present at the input terminals, connect a diode in reverse parallel across the input terminals and keep the reverse voltages below the reverse breakdown voltage.

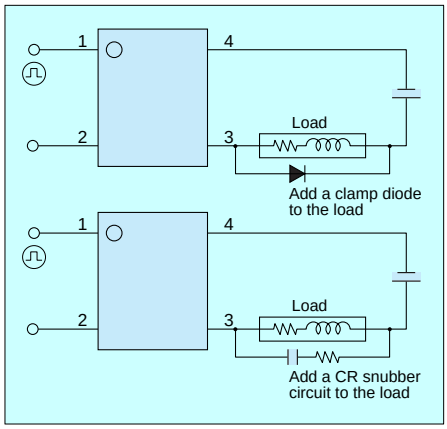


3. Recommended LED forward current (I_F)
It is recommended that the LED forward current (I_F) be kept at 5mA.

4. Ripple in the input power supply
If ripple is present in the input power supply, observe the following:
1) For LED operate current at E_{min}, maintain the value mentioned in the table of “Note 3. Recommended LED forward current (I_F).”
2) Keep the LED operate current at 50 mA or less at E_{max}.



5. Output spike voltages
1) If an inductive load generates spike voltages which exceed the absolute maximum rating, the spike voltage must be limited.
Typical circuits are shown below.

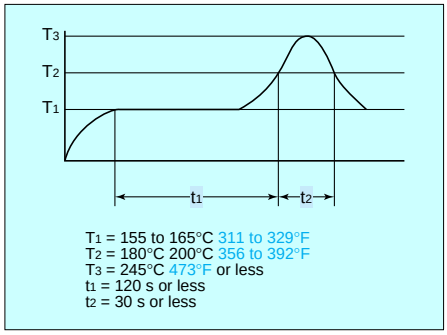


2) If spike voltages generated at the load are limited with a clamp diode and the circuit wires are long, spike voltages will occur by inductance. Keep wires as short as possible to minimize inductance.

6. Cleaning solvents compatibility
Dip cleaning with an organic solvent is recommended for removal of solder flux, dust, etc. Select a cleaning solvent from the following table. If ultrasonic cleaning is used, the severity of factors such as frequency, output power and cleaning solvent selected may cause loose wires and other defects. Make sure these conditions are correct before use. For details, please consult us.

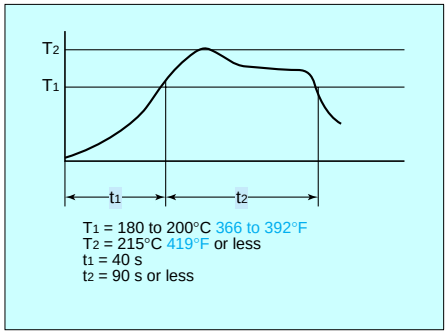
Cleaning solvent		Compatibility (❍: Yes ✕: No)
Chlorine-base	• Trichlene • Chloroethlene	❍
Adueous	• Indusco • Hollis • Lonco Terg	❍
Alcohol-base	• IPA • Ethanol	❍
Others	• Thinner • Gasoline	✕

7. Soldering
1) When soldering PC board terminals, keep soldering time to within 10 s at 260°C 500°F.
(1) IR (Infrared reflow) soldering method



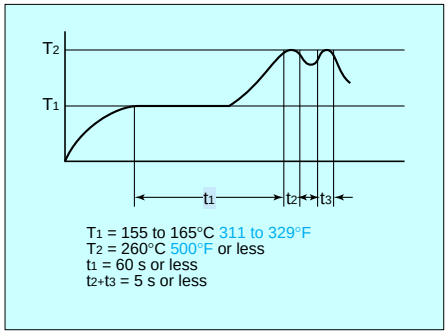
(4) Soldering iron method
Tip temperature: 280 to 300°C 536 to 572°F
Wattage: 30 to 60 W
Soldering time: within 5 s

2) When soldering surface-mount terminals, the following conditions are recommended.
(2) Vapor phase soldering method



(5) Others
Check mounting conditions before using other soldering methods (hot-air, hot plate, pulse heater, etc.)
• The temperature profile indicates the temperature of the soldered terminal on the surface of the PC board. The ambient temperature may increase excessively. Check the temperature under mounting conditions.

(3) Double wave soldering method

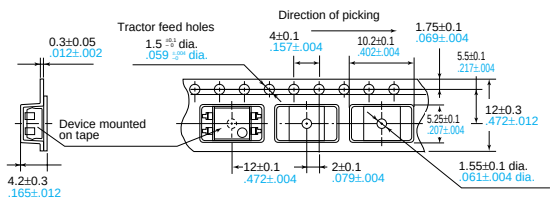
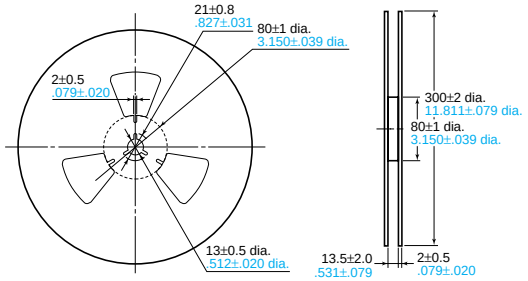


• The conditions for the infrared reflow soldering apply when preheating using the VPS method.

8. The following shows the packaging format

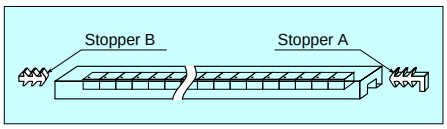
1) Tape and reel

mm inch

Type	Tape dimensions	Dimensions of paper tape reel
4-pin SMD type	 (1) When picked from 1/2-pin side: Part No. AQY❍❍❍GHAX (Shown above) (2) When picked from 3/4-pin side: Part No. AQY❍❍❍GHAZ	

2) Tube

Devices are packaged in a tube so pin No. 1 is on the stopper B side. Observe correct orientation when mounting them on PC boards.



9. Transportation and storage

1) Extreme vibration during transport will warp the lead or damage the relay. Handle the outer and inner boxes with care.

2) Storage under extreme conditions will cause soldering degradation, external appearance defects, and deterioration of the characteristics. The following storage conditions are recommended:

- Temperature: 0 to 45°C 32 to 113°F
- Humidity: Less than 70% R.H.
- Atomosphere: No harmful gasses such as sulfurous acid gas, minimal dust.